| Form PTO-1595 (Rev. 03-11) OMB No. 0851-0027 (exp. 03/31/2015)  | U.S. DEPARTMENT OF COMMERCE<br>Unked States Patent and Trademark Office  |  |
|---|--|--|
| RECORDATION FORM COVER SHEET  |  |  |
| PATENTS ONLY  |  |  |
| To the Director of the U.S. Patent and Trademark Office: Please   | record the attached documents or the new address(es) below.  |  |
| 1. Name of conveying party(ies):  | 2. Name and address of receiving party(iss)  |  |
| Kayo Sugimoto (02/02/2006), Kazuyuki Ogawa<br>(02/01/2006), Yuji Takimoto (10/03/2005), and<br>Makoto Sato (10/11/2005) | Name: Sony Corporation Internal Address:   |  |
| Additional name(s) of conveying party(les) attached?  | Street Address:  |  |
| 3. Nature of conveyance/Execution Date(s):  | 1-7-1 Konan, Minato-ku   |  |
| Execution Date(s): In parentheses after inventor name  X Assignment Merger Change of Name                               | Tokyo<br>108-0075<br>JAPAN   |  |
| Security Agreement Joint Research Agreement   | City:  |  |
| Government Interest Assignment  | State:   |  |
| Executive Order 9424, Confirmatory License  | Country: Zip:  |  |
| Other   | Additional name(s) & address(es) Yes X No attached?  |  |
| A. Patent Application No.(s) 13/888,665 Additional numbers attached?  | B. Patent No.(s)   |  |
| Name and address to whom correspondence<br>concerning document should be mailed:  | 8. Total number of applications and patents involved:  |  |
| Name: Davy E. Zoneraich<br>LERNER, DAVID, LITTENBERG,<br>KRUMHOLZ & MENTLIK, LLP  | 7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00  |  |
| Internal Address: Atty. Dkt.: SONYJP 3.3-357 CON  |  |  |
| Street Address: 600 South Avenue West   | X Authorized to be charged to deposit account  Enclosed  None required (government Interest not affecting title) |  |
| City: Westfield   | 8. Payment Information   |  |
| State: NJ Zip: 07090  |  |  |
| Phone Number: 908-654-5000  |  |  |
| Fax Number: 908-654-7866  | Deposit Account Number 12-1095   |  |
| Email Address: ataylor@ldlkm.com  | Authorized User Name Davy E. Zoneraich   |  |
| 9. Signature:   | May 7, 2013  |  |
| Signature   | Date   |  |
| Davy E. Zoneraich - 37,267  Name of Person Signing  | Total number of pages including cover sheet, attachments, and documents: 7                                       |  |

into which would conflict with this assignment and sale.

Docket Number: SONYJP 3.3-357 Sony Reference No.: S04P0115US00

### ASSIGNMENT

LDLKM

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

## COMMUNICATIONS SYSTEM AND METHOD, INFORMATION PROCESSING APPARATUS AND METHOD, INFORMATION MANAGEMENT APPARATUS AND METHOD, RECORDING MEDIUM AND PROGRAM

for which an International Application was filed on December 8, 2003, PCT/JP2003/015648, designating the United States;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo 141-0001, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents. Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remaneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: \_\_\_\_\_\_\_, Filing Date: \_\_\_\_\_\_.

This assignment executed on the dates indicated below.

| V-v- SUGIMOTO                                    | 2006/2/2                                  |
|--|---|
| Kayo SUGIMOTO Name of First or Sole Inventor     | Execution Date of U.S. Patent Application |
| Tokyo, Japan Residence of First or Sole Inventor |   |
| Kayo Sugimoto                                    | 2006/2/2                                  |
| Signature of First or Sole Inventor              | Date of this Assignment                   |
| 580003 LDOC                                      | ~ PATENT                                  |

DOCKET NUMBER: SUNTIF 3.3-337
Sony Reference No.: S04P0115US00

| Kazuyuki OGAWA                     | Total Date of LC Bears A Wester           |
|------------------------------------|---|
| Name of Second Joint Inventor      | Execution Date of U.S. Patent Application |
| Kanagawa, Japan                    |   |
| Residence of Second Joint Inventor |   |
| Signature of Second Joint Inventor | Date of this Assignment                   |
| Yuii TAKIMOTO                      |   |
| Name of Third Joint Inventor       | Execution Date of U.S. Patent Application |
| Kanagawa, Japan                    |   |
| Residence of Third Joint Inventor  |   |
| Signature of Third Joint Inventor  | Date of this Assignment                   |
| Makoto SATO                        |   |
| Name of Fourth Joint Inventor      | Execution Date of U.S. Patent Application |
| Fokyo, Japan                       |   |
| Residence of Fourth Joint Inventor |   |
| Signature of Fourth Joint Inventor | Date of this Assignment                   |

LDLKM

580003 1.DOC

Docket Number: SONYJP 3.3-357 Sonv Reference No.: S04P0115US00

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LDLKM

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NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property. Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

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Signature of First or Sole Inventor

Residence of First or Sole Inventor

Date of this Assignment

580003 LDOC

LDLKM

Sony Reference No.: S04P0115US00

| Kazuvuki OGAWA                     | ras. / 2406                               |
|------------------------------------|---|
| Name of Second Joint Inventor      | Execution Date of U.S. Patent Application |
| Kanagawa, Japan                    |   |
| Residence of Second Joint Inventor |   |
| langer your                        | Feb. 1 200 b                              |
| Signature of Second Joint Inventor | Date of this Assignment                   |
| Уніі ТАКІМОТО                      |   |
| Name of Third Joint Inventor       | Execution Date of U.S. Patent Application |
| Kanagawa, Japan                    |   |
| Residence of Third Joint Inventor  |   |
| Signature of Third Joint Inventor  | Date of this Assignment                   |
| Makoto SATO                        |   |
| Name of Fourth Joint Inventor      | Execution Date of U.S. Patent Application |
| Tokyo, Japan                       |   |
| Residence of Fourth Joint Inventor |   |
| Signature of Fourth John inventor  | Date of this Assignment                   |

Docket Number: SONYJP 3.3-357 Sony Reference No.: \$04P0115US00

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NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

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And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissues or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

|                                       | w: Application Number:, Filing Date:      |
|---------------------------------------|---|
| This assignment executed on the dates | indicated below.                          |
|                                       |   |
| vo SUGIMOTO                           |   |
| me of First or Sole Inventor          | Execution Date of U.S. Patent Application |
| kyo. Japan                            |   |
| sidence of First or Sole Inventor     |   |

Signature of First or Sole Inventor

Date of this Assignment ATENT

REEL: 030360 FRAME: 0206

LDLKM

Docket Number: SONYJP 3.3-357 Sony Reference No.: S04P0115US00

| Kazuwiki OGAWA                     |   |
|------------------------------------|---|
| Name of Second Joint Inventor      | Execution Date of U.S. Patent Application |
| Kanagawa, Japan                    |   |
| Residence of Second Joint Inventor |   |
| Signature of Second Joint Inventor | Date of this Assignment                   |
| Yuji TAKIMOTO                      | October 3 2005                            |
| Name of Third Joint Inventor       | Execution Date of U.S. Patent Application |
| Kanagawa, Japan                    |   |
| Residence of Third Joint Inventor  |   |
| Signature of Third Joint Inventor  | October 3 2005                            |
| Signature of Third Joint Inventor  | Date of this Assignment                   |
| Makoto SATO                        | October 11, 2005                          |
| Name of Fourth Joint Inventor      | Execution Date of U.S. Patent Application |
| Tokyo, Japan                       |   |
| Residence of Fourth Joint Inventor |   |
| Mukat Sito                         | October 11, 2005                          |
| Signature of Fourth Joint Inventor | Date of this Assignment                   |

PATENT REEL: 030360 FRAME: 0207

**RECORDED: 05/07/2013**